# Ultrafast Rectifier, 30 A FRED Pt®



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### LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS									
I <sub>F(AV)</sub>	30 A								
V <sub>R</sub>	300 V								
V <sub>F</sub> at I <sub>F</sub>	0.9 V								
t <sub>rr</sub> typ.	See Recovery table								
T <sub>J</sub> max.	175 °C								
Package	TO-247AC 2L								
Circuit configuration	Single								

### FEATURES

- Ultrafast recovery time
- Low forward voltage drop
- 175 °C operating junction temperature
- Low leakage current
- Designed and qualified according to JEDEC<sup>®</sup>-JESD 47



RoHS COMPLIANT HALOGEN FREE Available

 Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **DESCRIPTION / APPLICATION**

300 V series are the state of the art ultrafast recovery rectifiers designed with optimized performance of forward voltage drop and ultrafast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in the output rectification stage of SMPS, UPS, DC/DC converters as well as freewheeling diodes in low voltage inverters and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

### **MECHANICAL DATA**

Case: TO-247AC 2L

Molding compound meets UL 94 V-0 flammability rating

**Terminals:** matte tin plated leads, solderable per J-STD-002

ABSOLUTE MAXIMUM RATINGS										
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS						
Peak repetitive reverse voltage	V <sub>RRM</sub>		300	V						
Average rectified forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 143 °C	30	٨						
Non-repetitive peak surge current	I <sub>FSM</sub>	$T_{\rm J}$ = 25 °C, $t_{\rm p}$ = 10 ms	300	A						
Operating junction and storage temperatures	T <sub>J</sub> , T <sub>Stg</sub>		-65 to +175	°C						

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ unless otherwise specified)										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	I <sub>R</sub> = 100 μA	300	-	-	N				
Forward voltage	VF	I <sub>F</sub> = 30 A	-	1.08	1.25	V				
	۷F	I <sub>F</sub> = 30 A, T <sub>J</sub> = 125 °C	-	0.9	1.00					
De construit de construit		$V_{R} = V_{R}$ rated	-	0.05	60					
Reverse leakage current	I <sub>R</sub>	$T_J = 125 \text{ °C}, V_R = V_R \text{ rated}$	-	280	600 µA					
Junction capacitance	CT	V <sub>R</sub> = 300 V	-	90	-	pF				
Series inductance	LS	Measured lead to lead 5 mm from package body	-	3.5	-	nH				

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# Vishay Semiconductors

<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS			
Reverse recovery time		$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 50$	) A/µs, V <sub>R</sub> = 30 V	-	-	55				
	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	38	-	ns			
		T <sub>J</sub> = 125 °C		-	52	-				
Back receivery ourrent		T <sub>J</sub> = 25 °C	l <sub>F</sub> = 30 A dl <sub>F</sub> /dt = - 200 A/µs	-	2.8	-	А			
Peak recovery current	IRRM	T <sub>J</sub> = 125 °C	$V_{\rm B} = 200 \text{ V}$	-	7.3	-	~			
Reverse recovery charge	0	T <sub>J</sub> = 25 °C	VR - 200 V	-	53	-				
	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	190	-	nC			

THERMAL - MECHANICAL SPECIFICATIONS										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-65	-	175	°C				
Thermal resistance, junction to case per leg	R <sub>thJC</sub>		-	0.5	0.9					
Thermal resistance, junction to ambient	R <sub>thJA</sub>	Typical socket mount	-	-	40	°C/W				
Thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, flat, smooth and greased	-	0.4	-	-				
Weight			-	6.0	-	g				
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)				
Marking device		Case style TO-247AC 2L		30EF	PH03					

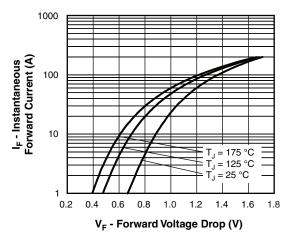


Fig. 1 - Typical Forward Voltage Drop Characteristics

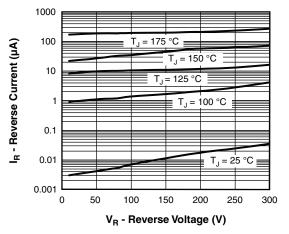


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

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## **VS-30EPH03-N3**

## **Vishay Semiconductors**



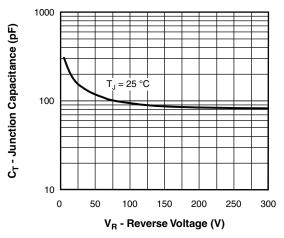


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

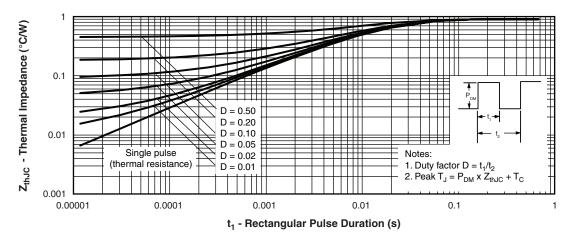
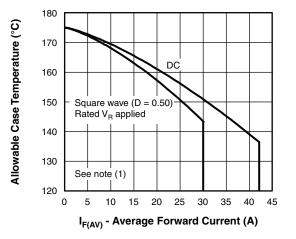
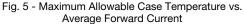


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics





#### Note

<sup>(1)</sup> Formula used:  $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$ ;

 $\begin{array}{l} Pd = \text{forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 6);} \\ Pd_{REV} = \text{inverse power loss} = V_{R1} \times I_{R} (1 - D); I_{R} \text{ at } V_{R1} = \text{rated } V_{R} \end{array}$ 

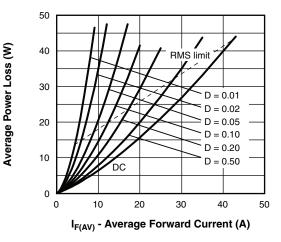


Fig. 6 - Forward Power Loss Characteristics

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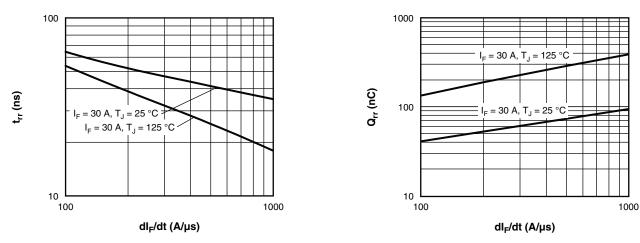


Fig. 7 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

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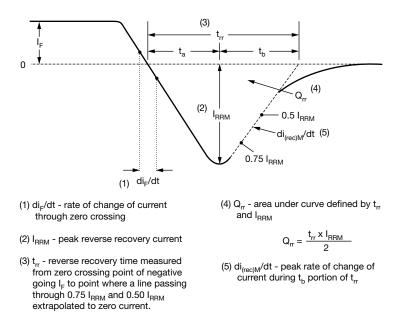


Fig. 9 - Reverse Recovery Waveform and Definitions



### **ORDERING INFORMATION TABLE**

Device code	VS-	30	Е	Р	н	03	-N3
		2	3	4	5	6	7
	1 .	- Visl	nay Sen	nicondu	ctors pro	oduct	
	2 -	- Cur	rent rati	ing (30 =	= 30 A)		
	3 -	- Circ	cuit conf	figuratio	n:		
		E =	single	diode			
	4	- Pac	kage:				
		P =	TO-247	7AC			
	5 -	- H=	hyperfa	ast recov	/ery		
	6	- Vol	tage rat	ing (03 =	= 300 V)	)	
	7 -	- Env	vironme	ntal digit			
		-N3	= halog	gen-free	, RoHS-	complia	ant and

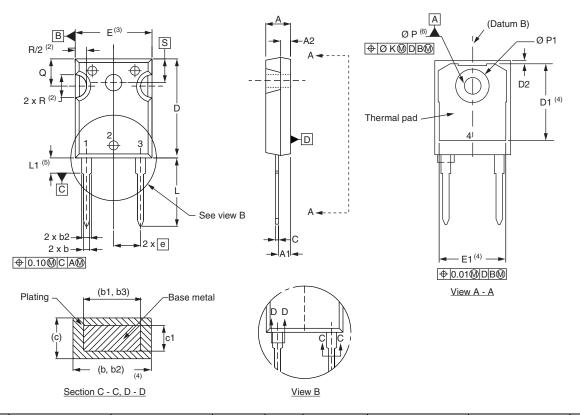
ORDERING INFORMATION (Example)										
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION							
VS-30EPH03-N3	25	500	Antistatic plastic tube							

LINKS TO RELATED DOCUMENTS								
Dimensions www.vishay.com/doc?96144								
Part marking information	www.vishay.com/doc?95648							



TO-247AC 2L

### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIM	IETERS	INC	HES	NOTES	NOTES		MILLIN	IETERS	INC	HES	NOTES
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES		SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
A	4.65	5.31	0.183	0.209			E	15.29	15.87	0.602	0.625	3
A1	2.21	2.59	0.087	0.102			E1	13.46	-	0.53	-	
A2	1.17	1.37	0.046	0.054			e	5.46	BSC	0.215	BSC	
b	0.99	1.40	0.039	0.055			ØК	0.2	254	0.0	)10	
b1	0.99	1.35	0.039	0.053			L	14.20	16.10	0.559	0.634	
b2	1.65	2.39	0.065	0.094			L1	3.71	4.29	0.146	0.169	
b3	1.65	2.34	0.065	0.092			ØР	3.56	3.66	0.14	0.144	
С	0.38	0.89	0.015	0.035			Ø P1	-	7.39	-	0.291	
c1	0.38	0.84	0.015	0.033			Q	5.31	5.69	0.209	0.224	
D	19.71	20.70	0.776	0.815	3		R	4.52	5.49	0.178	0.216	
D1	13.08	-	0.515	-	4		S 5.51 BSC 0.217 BSC					
D2	0.51	1.35	0.020	0.053								
NI - I												

#### Notes

<sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5M-1994

(2) Contour of slot optional

(3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

<sup>(4)</sup> Thermal pad contour optional with dimensions D1 and E1

<sup>(5)</sup> Lead finish uncontrolled in L1

<sup>(6)</sup> Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")

<sup>(7)</sup> Outline conforms to JEDEC<sup>®</sup> outline TO-247 with exception of dimension Q

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